



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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CMDD3003

SURFACE MOUNT  
LOW LEAKAGE SILICON  
SWITCHING DIODE

**SUPERmini™**



SOD-323 CASE



[www.centralsemi.com](http://www.centralsemi.com)

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMDD3003 type is a silicon switching diode manufactured by the epitaxial planar process, epoxy molded in a **SUPERmini™** surface mount package, designed for switching applications requiring a extremely low leakage diode.

**MARKING CODE: 03C**

**MAXIMUM RATINGS: (T<sub>A</sub>=25°C)**

	<b>SYMBOL</b>		<b>UNITS</b>
Continuous Reverse Voltage	V <sub>R</sub>	180	V
Average Rectified Current	I <sub>O</sub>	200	mA
Continuous Forward Current	I <sub>F</sub>	600	mA
Peak Repetitive Forward Current	I <sub>FRM</sub>	700	mA
Peak Forward Surge Current, tp=1.0μs	I <sub>FSM</sub>	2.0	A
Peak Forward Surge Current, tp=1.0s	I <sub>FSM</sub>	1.0	A
Power Dissipation	P <sub>D</sub>	250	mW
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Thermal Resistance	Θ <sub>JA</sub>	500	°C/W

**ELECTRICAL CHARACTERISTICS: (T<sub>A</sub>=25°C unless otherwise noted)**

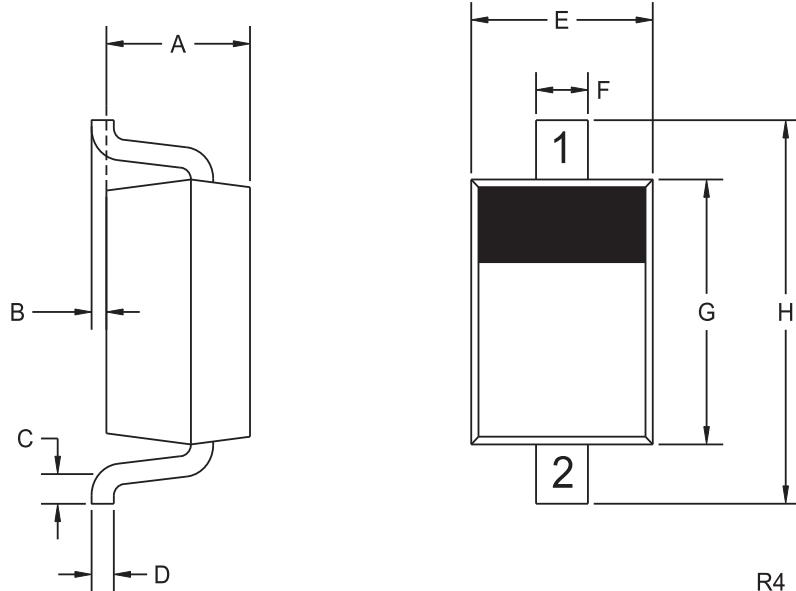
<b>SYMBOL</b>	<b>TEST CONDITIONS</b>	<b>MIN</b>	<b>MAX</b>	<b>UNITS</b>
I <sub>R</sub>	V <sub>R</sub> =125V		1.0	nA
I <sub>R</sub>	V <sub>R</sub> =125V, T <sub>A</sub> =150°C		3.0	μA
I <sub>R</sub>	V <sub>R</sub> =180V		10	nA
I <sub>R</sub>	V <sub>R</sub> =180V, T <sub>A</sub> =150°C		5.0	μA
BV <sub>R</sub>	I <sub>R</sub> =5.0μA	200		V
V <sub>F</sub>	I <sub>F</sub> =1.0mA	0.62	0.72	V
V <sub>F</sub>	I <sub>F</sub> =10mA	0.72	0.83	V
V <sub>F</sub>	I <sub>F</sub> =50mA	0.80	0.89	V
V <sub>F</sub>	I <sub>F</sub> =100mA	0.83	0.93	V
V <sub>F</sub>	I <sub>F</sub> =200mA	0.87	1.10	V
V <sub>F</sub>	I <sub>F</sub> =300mA	0.90	1.15	V
C <sub>T</sub>	V <sub>R</sub> =0, f=1.0MHz		4.0	pF

CMDD3003

SURFACE MOUNT  
LOW LEAKAGE SILICON  
SWITCHING DIODE

**Central**  
Semiconductor Corp.™

SOD-323 CASE - MECHANICAL OUTLINE



R4

**LEAD CODE:**

- 1) CATHODE
- 2) ANODE

**MARKING CODE: 03C**

SYMBOL	DIMENSIONS			
	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.031	0.039	0.80	1.00
B	0.000	0.004	0.00	0.10
C	0.008	-	0.20	-
D	0.004	0.007	0.11	0.19
E	0.045	0.053	1.15	1.35
F	-	0.014	-	0.35
G	0.063	0.071	1.60	1.80
H	0.094	0.102	2.40	2.60

SOD-323 (REV: R4)

R1 (8-January 2010)

## OUTSTANDING SUPPORT AND SUPERIOR SERVICES



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### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

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### DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

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### REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix " TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

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### CONTACT US

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